ALUMINUM ELECTROLYTIC CAPACITORS





3.95mmL MAX. Chip Type, Bi-polarized



• Chip type with 3.95mmL MAX, height.

- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine fed with carrier tape.
- Compliant to the RoHS directive (2011/65/EU).

Products which are scheduled to be discontinued. Not recommended for new designs





Specifications

Item	Performance Characteristics										
Category Temperature Range	-40 to +85°C										
Rated Voltage Range	6.3 to 50V										
Rated Capacitance Range	0.1 to 47µF										
Capacitance Tolerance	±20% at 120Hz, 20°C										
Leakage Current	After 2 minutes' application of rated voltage, leakage current is not more than 0.05 CV or 10 (μA), whichever is greater.										
Tangent of loss angle (tan δ)	Measurement frequency : 120Hz at 20°C										
	Rated voltage (V)	6.3			16		25	35		50	
	tan δ (MAX.)	0.30	0.24		0.20	0	0.18	0.16		0.16	
	Measurement frequency : 120Hz										
Stability at Low Tomporature	Rated voltage (V)		6.3	10		16	25		35	50	
Stability at Low Temperature	Impedance ratio Z-25°C / Z-		4	3		2	2		2	2	
	ZT / Z20 (MAX.) Z-40°C / Z-	+20°C	8	8		4	4		3	3	
	the capacitors are restored to 20°C after the rated					Capacitance change Within ±				in ±30% c	of the initial capacitance value
Endurance						tan δ 300% or le					han the initial specified value
	voltage is applied for 1000 hou polarity inverted every 250 hou			the	L	Leaka	ge currer	nt	Less	than or e	qual to the initial specified value
Shelf Life	After storing the capacitors un clause 4.1 at 20°C, they shall r										reatment based on JIS C 5101-4 above.
Resistance to soldering heat	The capacitors are kept on a hot plate for 30 seconds, which is maintained at 250°C. The capacitors shall meet the characteristic requirements listed at right when they are						Capacit	±10% of the initial capacitance value			
							tan ô Less			Less the	an or equal to the initial specified value
Πσαι	removed from the plate and re-			т шеу а	are		Leakag	e curre	nt	Less the	an or equal to the initial specified value
Marking	Black print on the case top.										

Chip Type



Dimensions

V		6.3		10		16		2	5	35		50	
Сар. (µF)	Code	0.	J	1A 1C 1E		1V		1H					
0.1	0R1						1					4	1.0
0.22	R22	1										4	2.0
0.33	R33						1					4	2.8
0.47	R47						1					4	4.0
1	010	1					1					4	8.4
2.2	2R2						1			4	8.4	5	13
3.3	3R3						1	5	12	5	16	5	17
4.7	4R7	1				4	12	5	16	5	18	6.3	20
10	100	I		4	17	5	23	6.3	27	6.3	29		
22	220	5	28	6.3	33	6.3	37	1					1
33	330	6.3	37	6.3	41	6.3	49						
47	470	6.3	45				 					Case size ¢D (mm)	Rated ripple

Rated ripple current (mArms) at 85°C 120Hz

• Frequency coefficient of rated ripple current

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	Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more
	Coefficient	0.70	1.00	1.17	1.36	1.50

- Taping specifications are given in page 23.
- Recommended land size soldering by reflow are given in page 18,19.

Type numbering system (Example : 16V 10µF)

Please refer to page 3 for the minimum order quantity.

